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		·		1	ATTY. DOCKET NO.	SERIAL N	0.				
FOR	M PI	O-1449			AGL-10030302						
		PATENTS AND PUBLIC			APPLICANT						
APPLICANT'S INFORMATION DISCLOSURE STATEMENT					Qing Gan et al.						
(Use several sheets if necessary)					FILING DATE GROUP Herewith						
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^{*}Copies of these references are not enclosed pursuant to 37 CFR 1.98(d). (See accompanying IDS)

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LIST OF PATENTS AND PUBLICATIONS FOR APPLICANT'S INFORMATION DISCLOSURE					APPLICANT								
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